

# NTST60100CT, NTSB60100CT-1, NTSB60100CT, NTSJ60100CT

## Very Low Forward Voltage Trench-based Schottky Rectifier

Exceptionally Low  $V_F = 0.36\text{ V}$  at  $I_F = 5\text{ A}$

### Features

- Fine Lithography Trench-based Schottky Technology for Very Low Forward Voltage and Low Leakage
- Fast Switching with Exceptional Temperature Stability
- Low Power Loss and Lower Operating Temperature
- Higher Efficiency for Achieving Regulatory Compliance
- Low Thermal Resistance
- High Surge Capability
- Halide Free Devices Available
- These are Pb-Free Packages

### Typical Applications

- Switching Power Supplies including Notebook / Netbook Adapters, ATX and Flat Panel Display
- High Frequency and DC-DC Converters
- Freewheeling and OR-ing diodes
- Reverse Battery Protection
- Instrumentation

### Mechanical Characteristics

- Case: Epoxy, Molded
- Epoxy Meets Flammability Rating UL 94-0 @ 0.125 in
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Maximum for 10 sec

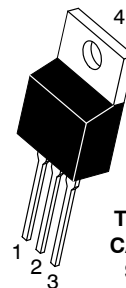
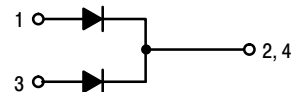


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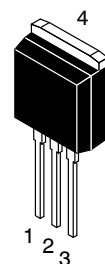
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VERY LOW FORWARD VOLT-  
AGE, LOW LEAKAGE SCHOT-  
TKY BARRIER  
RECTIFIERS 60 AMPERES,  
100 VOLTS

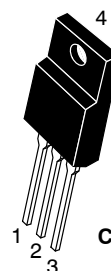
### PIN CONNECTIONS



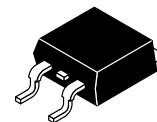
TO-220AB  
CASE 221A  
STYLE 6



I2PAK  
CASE 418D  
STYLE 3



TO-220FP  
CASE 221AH



D2PAK  
CASE 418B

### ORDERING INFORMATION

See detailed ordering and shipping information on page 6 of this data sheet.

# NTST60100CT, NTSB60100CT-1, NTSB60100CT, NTSJ60100CT

## MAXIMUM RATINGS

| Rating                                                                                                                                                                                                                                                                                                                                                           | Symbol                          | Value                 | Unit             |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------|-----------------------|------------------|
| Peak Repetitive Reverse Voltage<br>Working Peak Reverse Voltage<br>DC Blocking Voltage                                                                                                                                                                                                                                                                           | $V_{RRM}$<br>$V_{RWM}$<br>$V_R$ | 100                   | V                |
| Average Rectified Forward Current at Rated $V_R$<br>NTST60100CT, NTSB60100CT-1 and NTSB60100CT<br>(Rated $V_R$ , $T_C = 115^\circ\text{C}$ ) per Device<br>(Rated $V_R$ , $T_C = 125^\circ\text{C}$ ) per Diode<br>NTSJ60100CT<br>(Rated $V_R$ , $T_C = 80^\circ\text{C}$ ) per Device<br>(Rated $V_R$ , $T_C = 75^\circ\text{C}$ ) per Diode                    | $I_{F(AV)}$                     | 60<br>30<br>30<br>30  | A                |
| Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz)<br>NTST60100CT, NTSB60100CT-1 and NTSB60100CT<br>(Rated $V_R$ , $T_C = 105^\circ\text{C}$ ) per Device<br>(Rated $V_R$ , $T_C = 120^\circ\text{C}$ ) per Diode<br>NTSJ60100CT<br>(Rated $V_R$ , $T_C = 65^\circ\text{C}$ ) per Device<br>(Rated $V_R$ , $T_C = 55^\circ\text{C}$ ) per Diode | $I_{FRM}$                       | 120<br>60<br>30<br>30 | A                |
| Nonrepetitive Peak Surge Current<br>(Surge applied at rated load conditions halfwave, single phase, 60 Hz)                                                                                                                                                                                                                                                       | $I_{FSM}$                       | 250                   | A                |
| Operating Junction Temperature                                                                                                                                                                                                                                                                                                                                   | $T_J$                           | -40 to +150           | $^\circ\text{C}$ |
| Storage Temperature                                                                                                                                                                                                                                                                                                                                              | $T_{stg}$                       | -40 to +150           | $^\circ\text{C}$ |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

## THERMAL CHARACTERISTICS

| Rating                                                                    | Symbol          | NTST60100CT,<br>NTSB60100CT-1,<br>NTSB60100CT | NTSJ60100CT  | Unit                      |
|---------------------------------------------------------------------------|-----------------|-----------------------------------------------|--------------|---------------------------|
| Maximum Thermal Resistance<br>Junction-to-Case<br>Per Diode<br>Per Device | $R_{\theta JC}$ | 1.10<br>0.67                                  | 3.60<br>3.17 | $^\circ\text{C}/\text{W}$ |

## ELECTRICAL CHARACTERISTICS (Per Leg unless otherwise noted)

| Rating                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            | Symbol | Typ                                                                              | Max                                                            | Unit                                           |
|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|----------------------------------------------------------------------------------|----------------------------------------------------------------|------------------------------------------------|
| Maximum Instantaneous Forward Voltage (Note 1)<br>( $I_F = 5\text{ A}$ , $T_J = 25^\circ\text{C}$ )<br>( $I_F = 10\text{ A}$ , $T_J = 25^\circ\text{C}$ )<br>( $I_F = 15\text{ A}$ , $T_J = 25^\circ\text{C}$ )<br>( $I_F = 20\text{ A}$ , $T_J = 25^\circ\text{C}$ )<br>( $I_F = 30\text{ A}$ , $T_J = 25^\circ\text{C}$ )<br><br>( $I_F = 5\text{ A}$ , $T_J = 125^\circ\text{C}$ )<br>( $I_F = 10\text{ A}$ , $T_J = 125^\circ\text{C}$ )<br>( $I_F = 15\text{ A}$ , $T_J = 125^\circ\text{C}$ )<br>( $I_F = 20\text{ A}$ , $T_J = 125^\circ\text{C}$ )<br>( $I_F = 30\text{ A}$ , $T_J = 125^\circ\text{C}$ ) | $V_F$  | 0.45<br>0.52<br>0.58<br>0.63<br>0.73<br><br>0.36<br>0.45<br>0.53<br>0.58<br>0.66 | -<br>-<br>0.63<br>-<br>0.84<br><br>-<br>-<br>0.58<br>-<br>0.70 | V                                              |
| Maximum Instantaneous Reverse Current (Note 1)<br>( $V_R = 80\text{ V}$ , $T_J = 25^\circ\text{C}$ )<br>( $V_R = 80\text{ V}$ , $T_J = 125^\circ\text{C}$ )<br><br>(Rated dc Voltage, $T_J = 25^\circ\text{C}$ )<br>(Rated dc Voltage, $T_J = 125^\circ\text{C}$ )                                                                                                                                                                                                                                                                                                                                                | $I_R$  | 20<br>15<br><br>40<br>30                                                         | 500<br>20<br><br>1000<br>85                                    | $\mu\text{A}$<br>mA<br><br>$\mu\text{A}$<br>mA |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$

TYPICAL CHARACTERISTICS

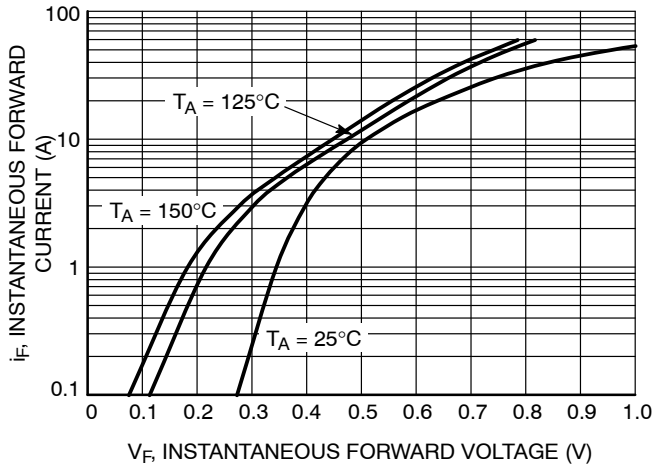


Figure 1. Typical Instantaneous Forward Characteristics

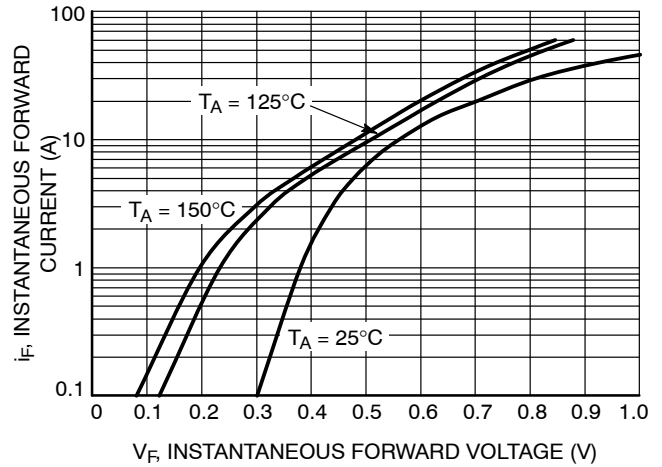


Figure 2. Maximum Instantaneous Forward Characteristics

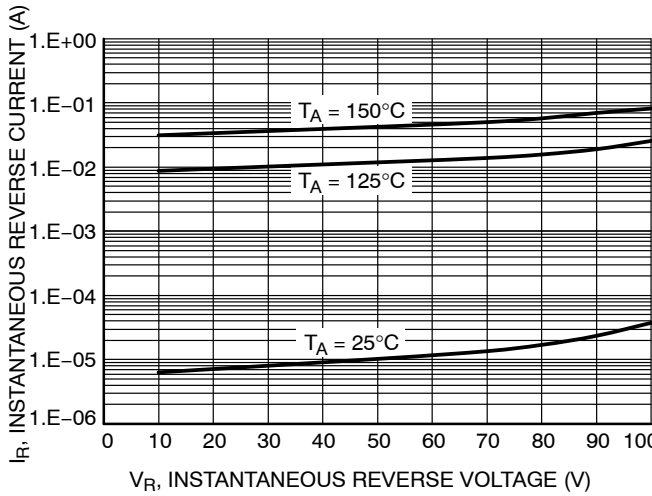


Figure 3. Typical Reverse Characteristics

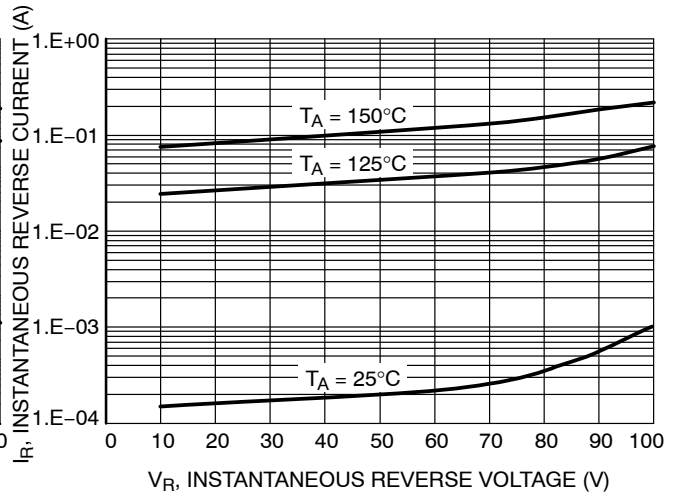


Figure 4. Maximum Reverse Characteristics

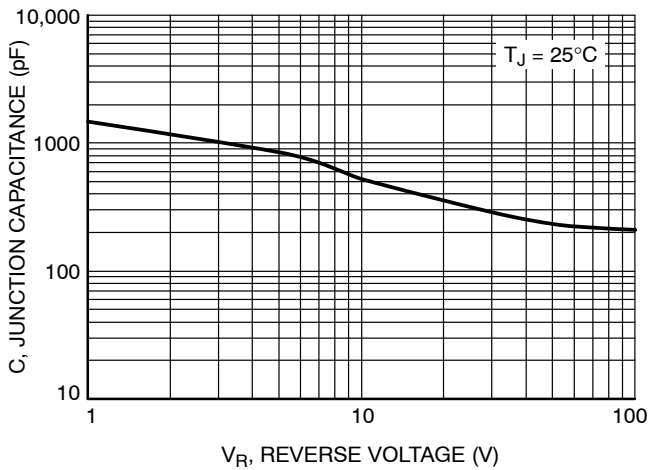


Figure 5. Typical Junction Capacitance

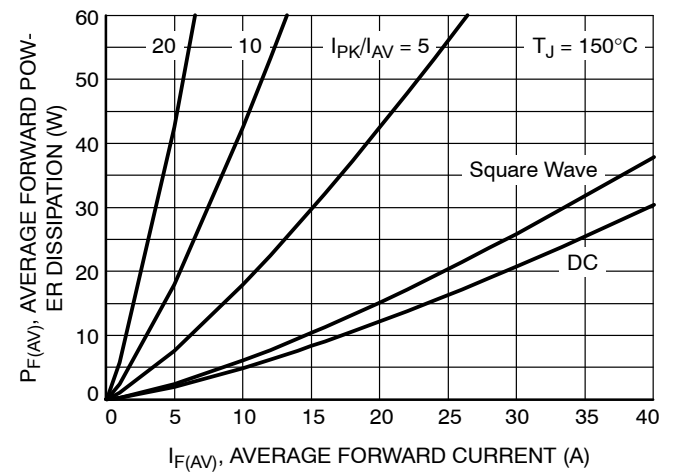


Figure 6. Forward Power Dissipation

# NTST60100CT, NTSB60100CT-1, NTSB60100CT, NTSJ60100CT

## TYPICAL CHARACTERISTICS

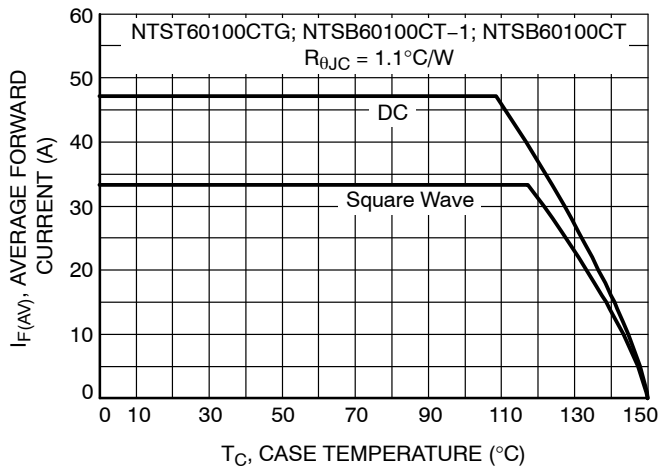


Figure 7. Current Derating per Diode

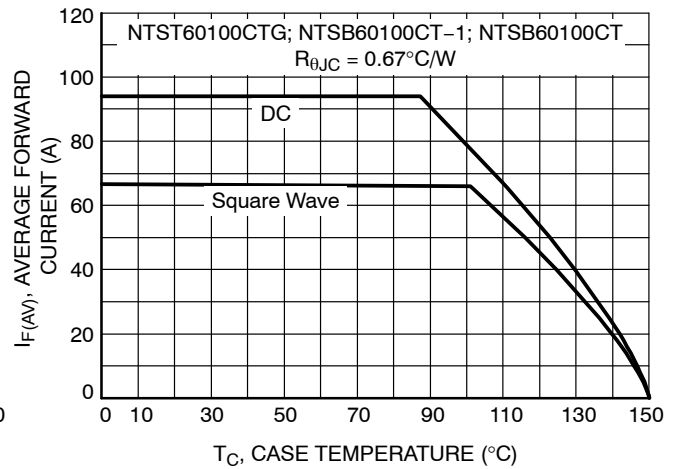


Figure 8. Current Derating per Device

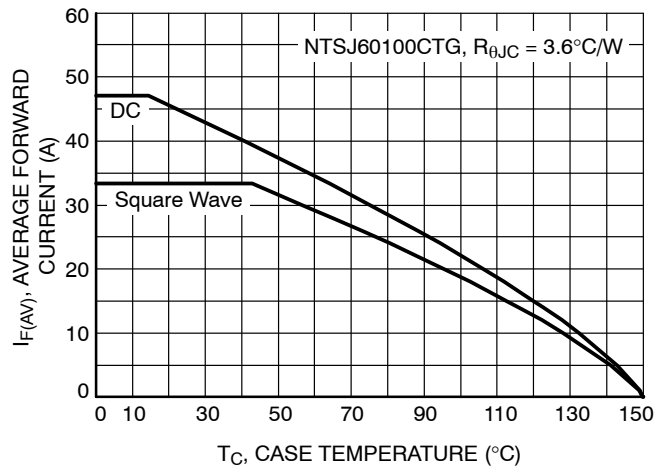


Figure 9. Current Derating per Diode

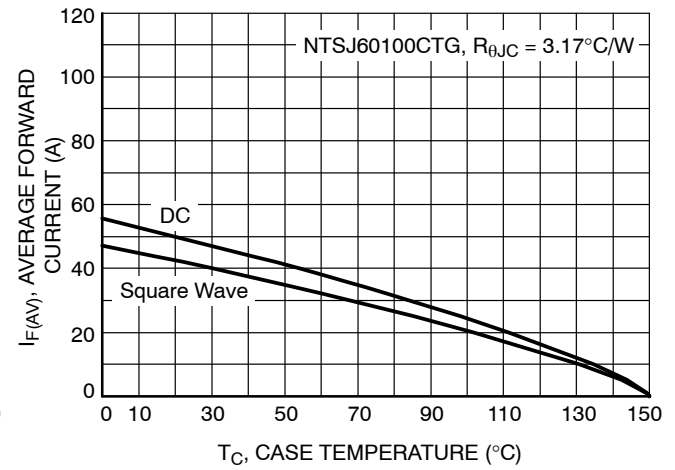


Figure 10. Current Derating per Device

# NTST60100CT, NTSB60100CT-1, NTSB60100CT, NTSJ60100CT

## TYPICAL CHARACTERISTICS

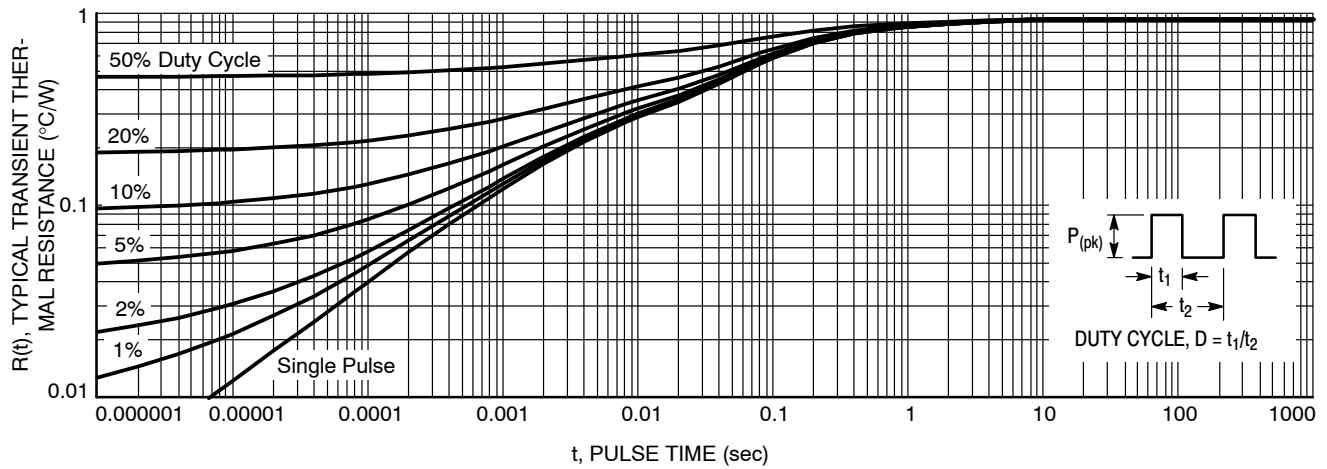


Figure 11. NTST60100CT, NTSB60100CT-1G and NTSB60100CT Typical Transient Thermal Response

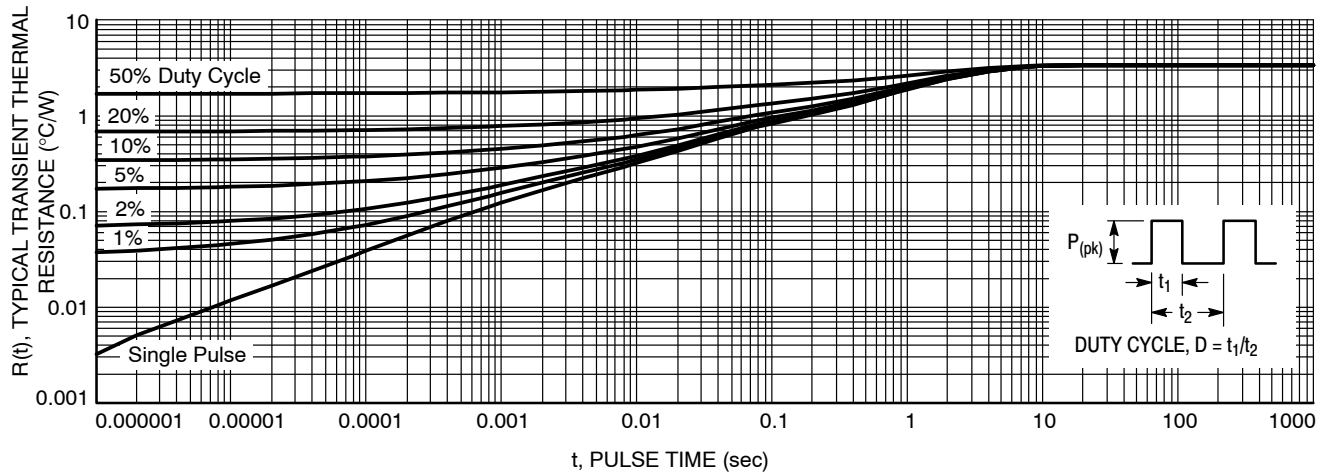


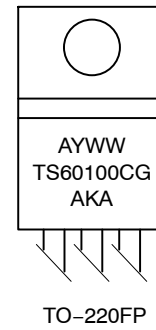
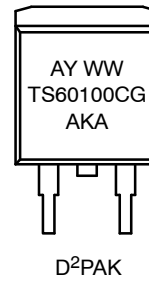
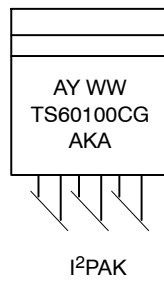
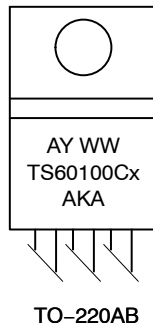
Figure 12. NTSJ60100CTG Typical Transient Thermal Response

# NTST60100CT, NTSB60100CT-1, NTSB60100CT, NTSJ60100CT

## ORDERING INFORMATION

| Device         | Package                            | Shipping          |
|----------------|------------------------------------|-------------------|
| NTST60100CTG   | TO-220AB<br>(Pb-Free)              | 50 Units / Rail   |
| NTSB60100CT-1G | I <sup>2</sup> PAK<br>(Pb-Free)    | 50 Units / Rail   |
| NTSB60100CTG   | D <sup>2</sup> PAK<br>(Pb-Free)    | 50 Units / Rail   |
| NTSB60100CTT4G | D <sup>2</sup> PAK<br>(Pb-Free)    | 800 / Tape & Reel |
| NTSJ60100CTG   | TO-220FP<br>(Halide-Free, Pb-Free) | 50 Units / Rail   |

## MARKING DIAGRAMS

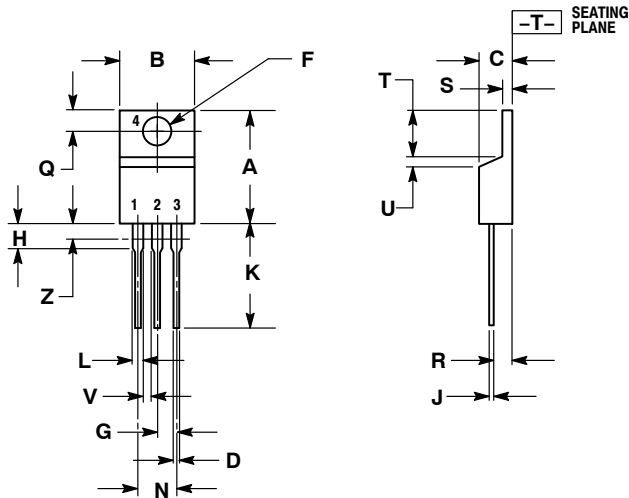


A = Assembly Location  
 Y = Year  
 WW = Work Week  
 AKA = Polarity Designator  
 x = G or H  
 G = Pb-Free Package  
 H = Halide-Free Package

# NTST60100CT, NTSB60100CT-1, NTSB60100CT, NTSJ60100CT

## PACKAGE DIMENSIONS

### TO-220 CASE 221A-09 ISSUE AH



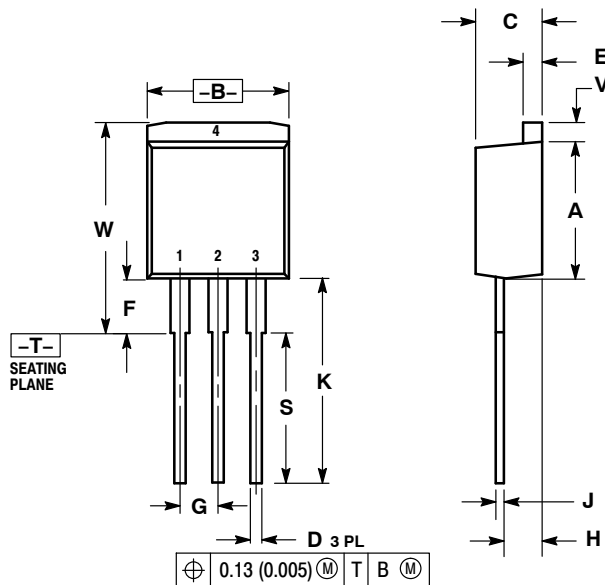
- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

| DIM | INCHES |       | MILLIMETERS |       |
|-----|--------|-------|-------------|-------|
|     | MIN    | MAX   | MIN         | MAX   |
| A   | 0.570  | 0.620 | 14.48       | 15.75 |
| B   | 0.380  | 0.415 | 9.66        | 10.53 |
| C   | 0.160  | 0.190 | 4.07        | 4.83  |
| D   | 0.025  | 0.038 | 0.64        | 0.96  |
| F   | 0.142  | 0.161 | 3.61        | 4.09  |
| G   | 0.095  | 0.105 | 2.42        | 2.66  |
| H   | 0.110  | 0.161 | 2.80        | 4.10  |
| J   | 0.014  | 0.024 | 0.36        | 0.61  |
| K   | 0.500  | 0.562 | 12.70       | 14.27 |
| L   | 0.045  | 0.060 | 1.15        | 1.52  |
| N   | 0.190  | 0.210 | 4.83        | 5.33  |
| Q   | 0.100  | 0.120 | 2.54        | 3.04  |
| R   | 0.080  | 0.110 | 2.04        | 2.79  |
| S   | 0.045  | 0.055 | 1.15        | 1.39  |
| T   | 0.235  | 0.255 | 5.97        | 6.47  |
| U   | 0.000  | 0.050 | 0.00        | 1.27  |
| V   | 0.045  | ---   | 1.15        | ---   |
| Z   | ---    | 0.080 | ---         | 2.04  |

STYLE 6:

- PIN 1. ANODE  
2. CATHODE  
3. ANODE  
4. CATHODE

### I<sup>2</sup>PAK (TO-262) CASE 418D-01 ISSUE D



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.

| DIM | INCHES |       | MILLIMETERS |       |
|-----|--------|-------|-------------|-------|
|     | MIN    | MAX   | MIN         | MAX   |
| A   | 0.335  | 0.380 | 8.51        | 9.65  |
| B   | 0.380  | 0.406 | 9.65        | 10.31 |
| C   | 0.160  | 0.185 | 4.06        | 4.70  |
| D   | 0.026  | 0.035 | 0.66        | 0.89  |
| E   | 0.045  | 0.055 | 1.14        | 1.40  |
| F   | 0.122  | REF   | 3.10        | REF   |
| G   | 0.100  | BSC   | 2.54        | BSC   |
| H   | 0.094  | 0.110 | 2.39        | 2.79  |
| J   | 0.013  | 0.025 | 0.33        | 0.64  |
| K   | 0.500  | 0.562 | 12.70       | 14.27 |
| S   | 0.390  | REF   | 9.90        | REF   |
| V   | 0.045  | 0.070 | 1.14        | 1.78  |
| W   | 0.522  | 0.551 | 13.25       | 14.00 |

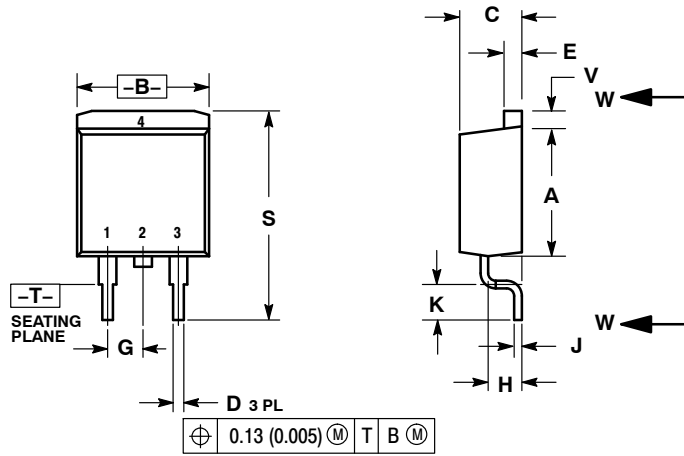
STYLE 3:

- PIN 1. ANODE  
2. CATHODE  
3. ANODE  
4. CATHODE

# NTST60100CT, NTSB60100CT-1, NTSB60100CT, NTSJ60100CT

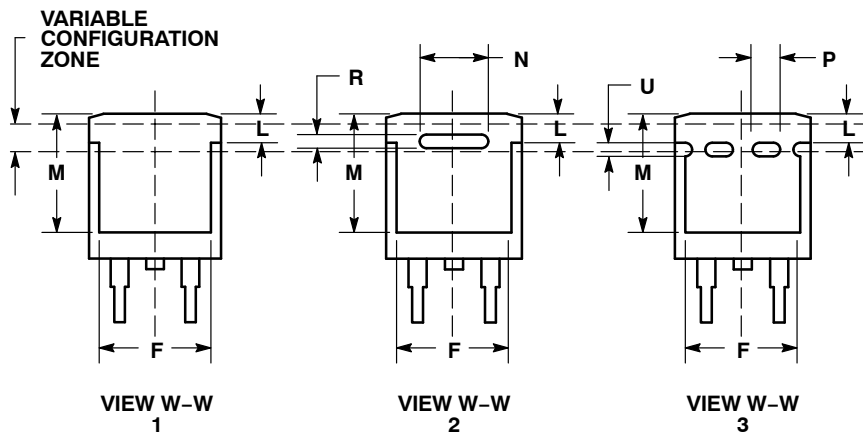
## PACKAGE DIMENSIONS

### D<sup>2</sup>PAK 3 CASE 418B-04 ISSUE K



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. 418B-01 THRU 418B-03 OBSOLETE, NEW STANDARD 418B-04.

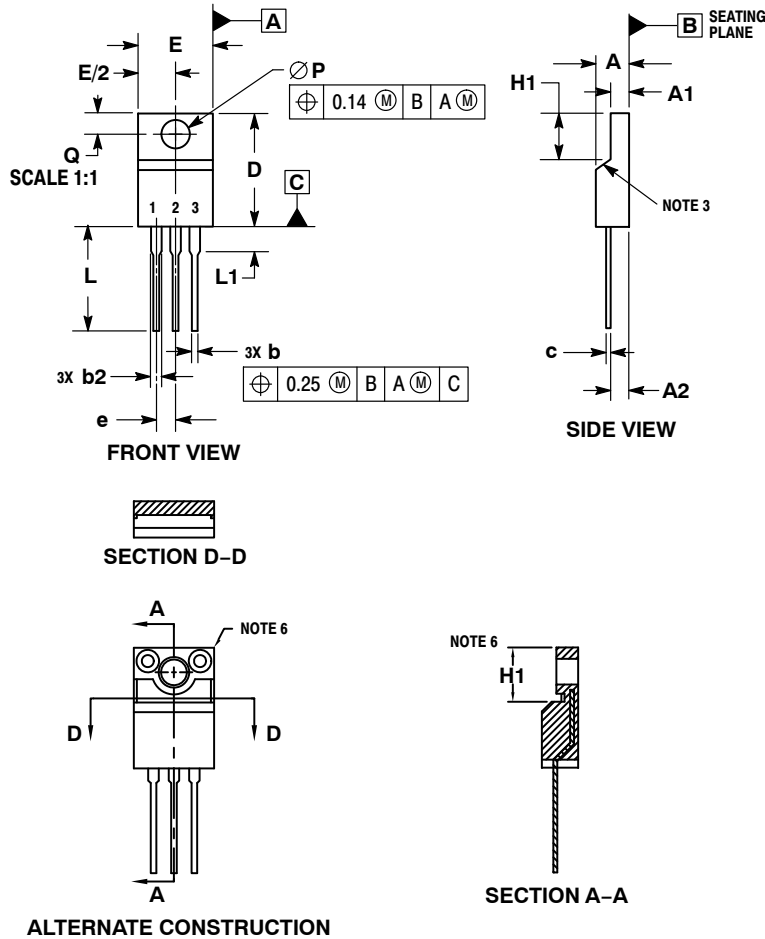
| DIM | INCHES    |       | MILLIMETERS |       |
|-----|-----------|-------|-------------|-------|
|     | MIN       | MAX   | MIN         | MAX   |
| A   | 0.340     | 0.380 | 8.64        | 9.65  |
| B   | 0.380     | 0.405 | 9.65        | 10.29 |
| C   | 0.160     | 0.190 | 4.06        | 4.83  |
| D   | 0.020     | 0.035 | 0.51        | 0.89  |
| E   | 0.045     | 0.055 | 1.14        | 1.40  |
| F   | 0.310     | 0.350 | 7.87        | 8.89  |
| G   | 0.100 BSC |       | 2.54 BSC    |       |
| H   | 0.080     | 0.110 | 2.03        | 2.79  |
| J   | 0.018     | 0.025 | 0.46        | 0.64  |
| K   | 0.090     | 0.110 | 2.29        | 2.79  |
| L   | 0.052     | 0.072 | 1.32        | 1.83  |
| M   | 0.280     | 0.320 | 7.11        | 8.13  |
| N   | 0.197 REF |       | 5.00 REF    |       |
| P   | 0.079 REF |       | 2.00 REF    |       |
| R   | 0.039 REF |       | 0.99 REF    |       |
| S   | 0.575     | 0.625 | 14.60       | 15.88 |
| V   | 0.045     | 0.055 | 1.14        | 1.40  |



# NTST60100CT, NTSB60100CT-1, NTSB60100CT, NTSJ60100CT

## PACKAGE DIMENSIONS

### TO-220 FULLPACK, 3-LEAD CASE 221AH ISSUE F



#### NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. CONTOUR UNCONTROLLED IN THIS AREA.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH AND GATE PROTRUSIONS. MOLD FLASH AND GATE PROTRUSIONS NOT TO EXCEED 0.13 PER SIDE. THESE DIMENSIONS ARE TO BE MEASURED AT OUTERMOST EXTREME OF THE PLASTIC BODY.
5. DIMENSION b2 DOES NOT INCLUDE DAMBAR PROTRUSION. LEAD WIDTH INCLUDING PROTRUSION SHALL NOT EXCEED 2.00.
6. CONTOURS AND FEATURES OF THE MOLDED PACKAGE BODY MAY VARY WITHIN THE ENVELOPE DEFINED BY DIMENSIONS A1 AND H1 FOR MANUFACTURING PURPOSES.

| MILLIMETERS |          |       |
|-------------|----------|-------|
| DIM         | MIN      | MAX   |
| A           | 4.30     | 4.70  |
| A1          | 2.50     | 2.90  |
| A2          | 2.50     | 2.90  |
| b           | 0.54     | 0.84  |
| b2          | 1.10     | 1.40  |
| c           | 0.49     | 0.79  |
| D           | 14.70    | 15.30 |
| E           | 9.70     | 10.30 |
| e           | 2.54 BSC |       |
| H1          | 6.60     | 7.10  |
| L           | 12.50    | 14.73 |
| L1          | ---      | 2.80  |
| P           | 3.00     | 3.40  |
| Q           | 2.80     | 3.20  |

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- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

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